

Serial No. : 2023-0384 DATE: 2023/6/19

SPECIFICATION

Product Name	CRYSTAL OSCILLATOR	
Туре	DSO221SXF	
Nominal Frequency	100.000MHz	
Spec No.	7FE10000A10	

If there is a change in this specifications, the specification number may be changed.

	RECEIPT	
DATE		
RECEIVED		(signature) (name)

General Manufacturer of Quartz Devices

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1. Device name SPXO (Output specification C-MOS)

2. Type name DSO221SXF

3. Nominal frequency 100.000MHz

4. Absolute maximum ratings

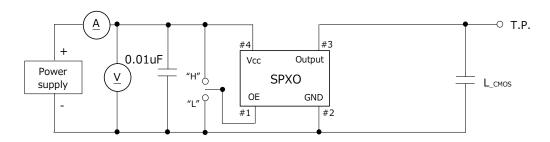
Item	Symbol	Rating	Unit
Supply voltage	Vcc	-0.3 ∼ +4.5	V
Storage temperature range	T_stg	-40 ∼ +85	$^{\circ}$

5. Electrical characteristics

Item	Symbol	Symbol Limits			Unit	Condition	
Item	Symbol	min.	typ.	max.	Offic	Conc	IILIOII
Total frequency tolerance	F_tol	-30	-	+30	ppm	+3.3±0.3V	-40∼+85℃
Operating temperature range	T_use	-40	-	+85	\mathbb{C}	+3.3±0.3∀	-
Supply voltage	Vcc	+3.0	+3.3	+3.6	V	ı	-40∼+85℃
Current consumption (No load)	Icc	-	-	10.0	mA		
Standby current	I std	_	_	0.01	mA		
(#1 Pin : "L" level)	1_5tu			0.01	ш		
Symmetry (Duty cycle)	SYM	45	-	55	%		
0 level voltage	Vol	-	-	Vcc×0.1	٧		
1 level voltage	Vон	Vcc×0.9	-	-	٧	+3.3V	+25±3℃
Rise & Fall time	tr / tf	-	-	3	ns	+3.3∀	+23±3 C
Load condition	L_cmos	-	-	15	рF		
0 level input voltage	VIL	-	-	Vcc×0.3	V		
1 level input voltage	VIH	Vcc×0.7	-	-	V		
Output disable time	tPLZ	-	-	200	ns		
Output enable time	tPZL	-	-	2	ms		

Measurement circuit and output wave form is refer to Fig.1. and Fig.2.

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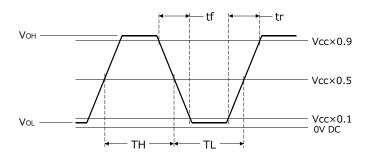


Function

1 dilectori	
#1 Input	#3 Output condition
Н	Oscillation out
L	High Z

*L_cmos : Total fixture and probe capacitance (Refer to Electric characteristics)

Fig.1 Measurement circuit



SYM= $TH / (TH + TL) \times 100(\%)$

Fig.2 Output wave Form

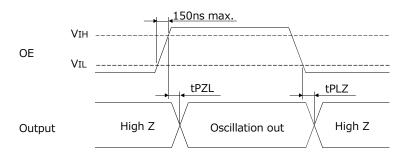
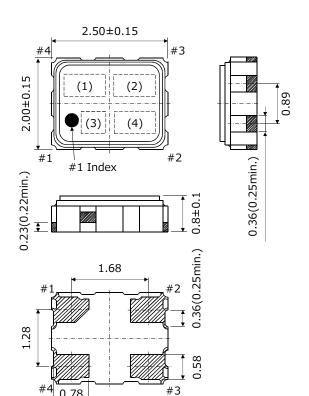


Fig.3 Input output condition

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6. Dimensions and Marking

Dimensions



Pin connections

Pin No.	Connection
#1	OE(Output enable)
#2	GND
#3	Output
#4	Vcc

Unit: mm

Dimensional tolerance : ± 0.1 (Unless otherwise noted)

6.2 Marking

- (1) Model code SXF
- (2) Frequency ex.) 100.000MHz \rightarrow 100.
- (3) Logo (4) Lot No.
- D

ex.) $2023/01/01 \rightarrow$ Year : The last digit of the year

Week: We gave the sequence of week numbers 01(first week) for production date.

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There are starting from 1st of Jan. However, add '0' figure to the first week during the nine weeks.

The week means are from Sunday to Saturday.

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7. Mechanical characteristics

7.1 Shock

7.1.1 Mounting drop

A soldered and mounted FR-4 board with thickness of 1.6mm is attached to 100g of aluminum material, and 10cycles of X, Y and Z axis directions (6directions) are dropped on the concrete from height of 150cm. The component shall satisfy requirement of frequency change before and after is within ±8ppm.

7.1.2 Acceleration

6ms/1000m/s² to X, Y and Z axes (6directions), 10times.

The component shall satisfy requirement of frequency change before and after is within ± 8 ppm. No visible damage.

7.2 Vibration

Vibration frequency $10\sim2000$ Hz, amplitude 1.5mm ($10\sim55$ Hz), acceleration 200m/s² ($55\sim2000$ Hz), 2h in X, Y and Z direction with 20min period.

The component shall satisfy requirement of frequency change before and after is within ±8ppm. No visible damage.

7.3 Sealing tightness

Leak Rate 1.0x10⁻⁹ Pa·m³/s max. measured by Helium leak detector.

7.4 Solderability

Rosin flux and immerse in soldering bath at $+245\pm5\%$ for $3\pm0.5s$, and 90% or more of the terminal area is new. It must be covered with solder.

7.5 Resistance to soldering heat (Reflow)

When the reflow profile in section 10.1 is measured after 3times, after returning to room temperature (2h intervals) and leaving it for 24 or 48h.

The component shall satisfy requirement of frequency change before and after is within ± 8 ppm. No visible damage.

8. Environment characteristics

8.1 Humidity

+60±2℃, 90~95% R.H., Duration of 240h.

Back to the room temperature first, then in 24h, be checked.

The component shall satisfy requirement of $\$ frequency change before and after is within ± 15 ppm. No visible damage.

8.2 Storage in low temperature

-40±2℃, Duration of 240h.

Back to the room temperature first, then in 24h, the component shall be checked.

The component shall satisfy requirement of frequency change before and after is within ± 15 ppm. No visible damage.

8.3 Storage in high temperature

+85±2℃, Duration of 240h.

Back to the room temperature first, then in 24h, the component shall be checked.

The component shall satisfy requirement of frequency change before and after is within ± 15 ppm. No visible damage.

8.4 Temperature cycles

-40°C (30min) \leftrightarrow +85°C (30min) shift time 2~3min, 200cycles.

Back to the room temperature first, then in 24h, the component shall be checked.

The component shall satisfy requirement of frequency change before and after is within ± 15 ppm. No visible damage.

8.5 High temperature operation

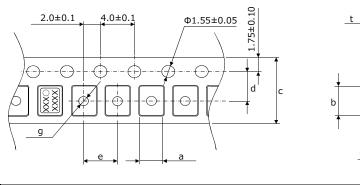
+85±2°C, maximum Vcc, Duration of 240h.

Back to the room temperature first, then in 24h, the component shall be checked.

The component shall satisfy requirement of $\$ frequency change before and after is within ± 15 ppm. No visible damage.

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9. Taping and Packing9.1 Emboss carrier tape specifications

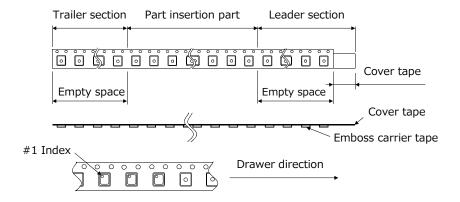


Material: PS (Conductivity) $\mathsf{Unit}:\mathsf{mm}$

Symbol	a	b	С	d	е	f	t	g
Size	2.3	2.8	8.0	3.50	4.0	1.15	0.30	Ф1.05
Size	±0.1	±0.1	±0.2	±0.05	±0.1	±0.10	±0.05	±0.05

9.2 Joint of tape

Emboss carrier tape and cover tape should not be jointed.



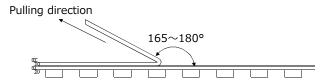
9.3 Taping dimension

Taping difficusion					
Covo	Cover tape	The length of cover tape in the leader is more than 350mm including			
	cover tape	empty space area.			
Leader section Emboss carrier		After all products were packaged, must remain more than 10pieces			
	tape	or 150mm empty space area, which should be sealed			
	tape	by cover tape.			
	Cover tape	The empty space area which are sealed by cover tape must remain			
Trailer section	Emboss carrier	more than 350mm.			
	tape				

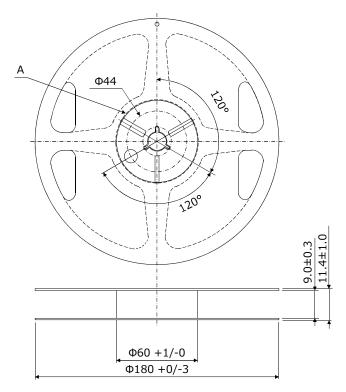
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9.4

Peeling strength of cover tape The peeling strength of cover tape pulls and keep to angle $165{\sim}180^\circ$ and make limit $0.1 \sim 0.7 N$ without prescription, when it pulled it with the speed of 300mm/min. (Others conform to JIS C 0806_1990)

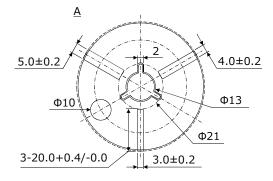


9.5 Reel specifications



Material: PS (Conductivity)

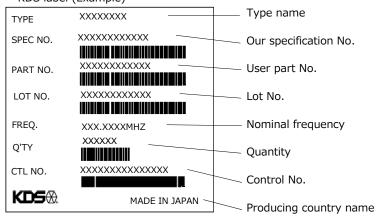
Unit:mm



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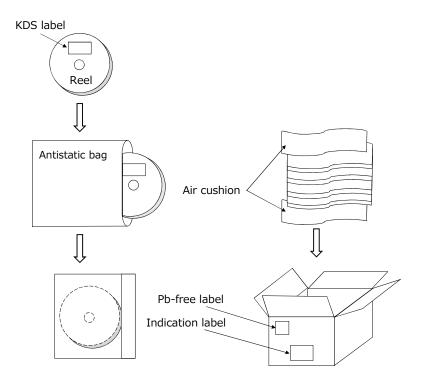
- 9.6 Storage condition
 - Temperature: +40°C max. Relative humidity: 80% max.
- 9.7 Standard packing quantity 3000pcs. / reel
- 9.8 Label Label is following information. Printing label at each reel.

KDS label (Example)



Pb-free label



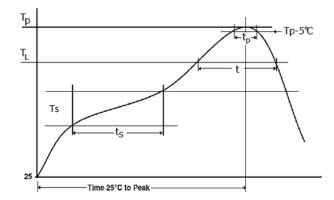


The product is packed up with the method which does not break in the handling by a shipping agent.

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10. Supplement

10.1 Reflow condition (Reference)

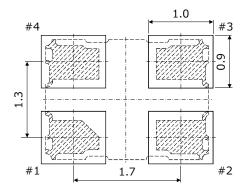


Ts	(℃)	150 ~ 200
ts time	(s)	60 ~ 120
TL	(℃)	217
t time	(s)	$60 \sim 150$
Тр	(℃)	max. 260
tp	(s)	max. 30

10.2 Reflow count (Reference)

Please stay with our proposed reflow condition and do then soldering 2times max.

10.3 Land pattern layout (Reference)



Land pattern

Unit: mm

10.4 Mounting

This component is designed for automatic insertion.

However you are requested to do the trial with your insertion machine in order to be sure of proper operation and no damage of component.

Please pay attention to board warp which may damage the component and cause soldering process. Please mount so that the metalize side and other electrical conductivity structures

(a main part lid is included) of the base side do not contact electrically.

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10.5 Cleaning

Cleaning liquid which corrodes Nickel shall not be used.

It may cause the problem on the surface color marking etc.

Ultrasonic cleaning is possible however you are requested to check on your board.

Because we only checked as single unit.

10.6 Handling

This product is designed to withstand Drop and Vibration, however, the crystal blank might be broken. So if excess force is given, please check the characteristics before use.

This product has C-MOS circuit inside.

Please pay attention to latch-up, static-electricity as same handling as other C-MOS devices.

10.7 By-pass capacitor

It has no by-pass capacitor integrated.

We recommend you to use capacitor (like ceramic chip capacitor) 0.01µF in-between Vcc and GND.

10.8 Storage

Please keep away from high temperature and high humidity, which may cause put solder ability. No direct Sunlight. No dew as well.

10.9 Thrust an ultrasonic cleaning

Because It use a small, thin crystal piece depending on a condition, the inside does resonance, and there is fear to cause the non-oscillation. When it's the worst, it may be destroyed. About the ultrasonic cleaning, it is use in the implementation of your company is in a state and confirming a thing without the influence in the appearance and a characteristic beforehand.

10.10 Point out supersonic wave welding

It can't recommend implementation by the supersonic wave welding and the processing so that the vibration excessive inside of the crystal oscillator propagates, and there is a threat that it cause characteristic deterioration and the non-oscillation.

10.11 RoHS compliance

Following material restricted by RoHS(2011/65/EU,(EU)2015/863) is not included or used.

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2023-0384 REVISION RECORD

Rev.No.	Date	Reason	Contents	Approved	Checked	Drawn
-	2023/06/19		The first edition	Y.Momoo	Y.Maeda	S.Yamamoto
	2023/00/19	-	The first edition	1.141011100	T.Maeua	3.141114111010